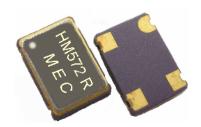


MERCURY Since 1973

The most efficient way to reduce EMI (Electromagnetic Interference) is to reduce it from its principle source – the clock oscillator. Mercury 3HM572, an integrated clock module composed of a spread spectrum clock and a quartz crystal, reduces EMI by 9 dB or more while providing the clock speed needed for the system. It is a drop-in replacement for standard 5x7 mm non-SSC clocks, no need to change the board or the solder pad layout.



The 3HM572 series (1.4 mm height) replaces the 3HM57 series (1.8 mm height). They are identical products, with the only difference being the package heights. The 3HM57 is obsolete. Please refer to Mercury PCN-111004 "Change HM57 to HM572".

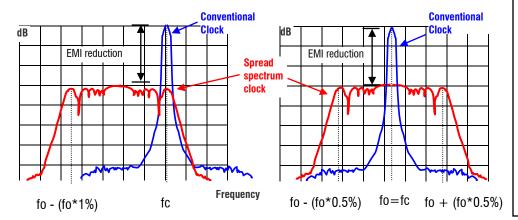
Applications:

- Printers; Multiple function printers (MPCs)
- Digital copiers; PDAs
- Networking; LAN / WAN; Routers
- Storage systems (CD-ROM, VCD, DVD & HDD)
- Scanner; Modems; Projectors
- Hand-held ID Readers

- Embedded systems; Electrical Musical Instrument
- Automotive: GPS Car Navigation Systems
- LCD PC Monitors / LCD TVs
- ADSL; PCMCIA
- Still Digital Cameras (SDCs)
- Medical Devices

Modulation Types DOWN or CENTER spread

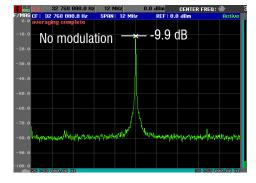
Down spread "D". "D1" as an example **Center spread "C".** "C0.5" as an example Output amplitude (dB) vs frequency span (MHz)

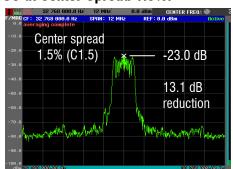


Spread Spectrum Clock (SSC):

Unlike the conventional clock, the mode energy of a spread spectrum clock is spread (distributed) over a wider bandwidth between two pre-defined frequency boundaries by the **frequency modulation** technique. The modulation carrier frequency is in the KHz range which makes the modulation process transparent to the oscillator frequency. This controlled modulation process can be on all of one side of the nominal frequency (**down spread**), which is preferred if system over-clocking is a concern, or 50% up and 50% down (**center spread**).

32.768 MHz non-SSC vs SSC at Center Spread 1.5%:





MERCURY www.mercury-crystal.com

Taiwan: TEL (886)-2-2406-2779, FAX (886)-2-2496-0769, e-mail: sales-tw@mercury-crystal.com U.S.A.: TEL (1)-909-466-0427, FAX (1)-909-466-0762, e-mail: sales-us@mercury-crystal.com Page 1 of 5 Oct. 18, 2011 Rev. 0



General Specifications: at Ta = +25°C, $C_L = 15$ pF

Mercury Model	3HM572	Group "R"			
Frequency Range	5.0 ∼160.0 MHz				
Spread Type	Total %	Down Spread (D)	Center Spread (C)		
Spread Percentage	1%	-1% (D1)	±0.5 (C0.5)		
(tolerance : $\pm 2\%$ of the total %)	3%	-3% (D3)	±1.5 (C1.5)		
EMI Reduction		i. 100 MHz at C0.5			
(EMI reduction is applied to the	-15 dB min. 100 MHz at C1.5				
entire spectrum)	With respect to the dB level when no modulation.				
Modulation Carrier Frequency	6.9 KHz min.; 55.5 KHz max.;				
(Dither rate)	Frequency dependent. Call for details.				
Output Logic		CMOS Square Wave			
Input Voltage (V _{DD})	$V_{DD} = +3.3 \text{ V D.C. } \pm 5\%$				
		cial (-10°C to $+70$ °C)			
Frequency Stability		"A": ±25 ppm; "B': ±50 ppm; "C":±100 ppm			
(exclude modulation)	Industrial (-40°C to +85°C):				
		" D ": ±25 ppm; " E ': ±50 ppm; " F ":±100 ppm			
Output Voltage "High"; "1"	2.0 V min.; 3.2 V typical (at 90% V_{DD})				
Output Voltage "Low"; "0"	0.8 V max. ; 0.2 V typical (at 10% V_{DD})				
Rise Time / Fall Time	4 n sec. max. (10% $V_{DD} \leftrightarrow 90\% V_{DD}$)				
Load	15 pF				
Start-up Time	2 ms typical; 5 ms max.				
Stabilization Time	2 ms max.				
Current Consumption	10.0 MHz: 7 mA; 32.768 MHz: 8 mA				
Current Consumption	75.0 MHz: 17 mA; 125 MHz: 18 mA				
Duty Cycle	$50\% \pm 5\%$. ($C_L = 15 \text{ pF}$;at $50\% \text{ V}_{DD}$)				
Cycle-to-cycle Jitter	±250 ps typical; ±300 ps max.				
Output Impedance	40 ohms	31			
Static Discharge Voltage		(per MIL-STD-883, n			
Aging	±5 ppm	per year max.; Ta=+	-25°C		
Packaging	16 mm tape and reel. 1000 pcs per reel				
Pin 1 Function	Output is high impedance when taken low.				
1 III 1 I UIIOUOII	Output enable /disable time: 100 ns max.				

Environmental Performance Specifications

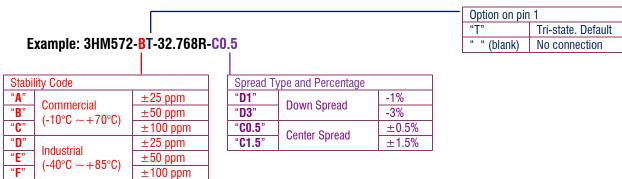
ivii oiliiliciitai 1 ci ioiliiailee o	poditionio		
RoHS Status	RoHS compliant, Pb (lead) free in accordance with EU Directive 2002/95/EC		
	6/6 (2002/95/EC) and WEEE (2002/96/EC)		
Moisture Sensitivity Level	evel Level 1 (infinite) according to IPC/JEDEC J-STD-020D.1		
Second Level Interconnect	e4		
Storage temp. range	-55 to +125°C		
Humidity	85% RH, 85°C, 48 hours		
Fine Leak / Gross Leak	MIL-Std-883, method 1014, condition A / MIL-Std-883, method 1014, condition C		
Solderability	MIL-STD-202F method 208E		
Reflow	260°C for 10 sec. 2X.		
Vibration	MIL-STD-202F method 204, 35G, 50 to 2000 Hz		
Shock	MIL-STD-202F method 213B, test condi. E, 1000GG ½ sine wave		
Resistance to Solvent	MIL-STD-202, method 215		
Temperature Cycling	MIL-STD-883, method 1010		
ESD Rating	>2000 V (per MIL-STD-883, method 3015)		
Pad Surface Finish	Gold (0.3 um min.) over nickel (1.27 um to 8.89 um)		
Weight of the Device	155 mg per unit typical		



Part Number Format and Example:

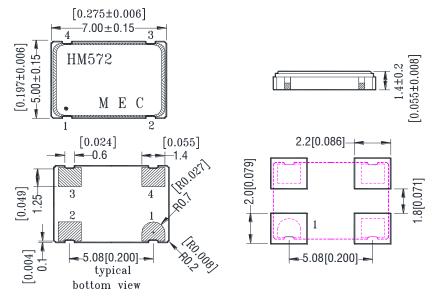
{_____}: User to specify.

Format: 3HM572-{<u>stability code}</u>T-{<u>nominal frequency</u>}R-{<u>spread type</u>}{<u>spread %</u>}



Description of the example: +3.3V HM572 series 5x7 mm spread spectrum clock, frequency stability is ± 50 ppm over -10° C to $+70^{\circ}$ C, Tri-state on pin 1, 32.768 MHz, center spread $\pm 0.5\%$

HM572 Package Dimensions and Recommended Solder Pad Layout



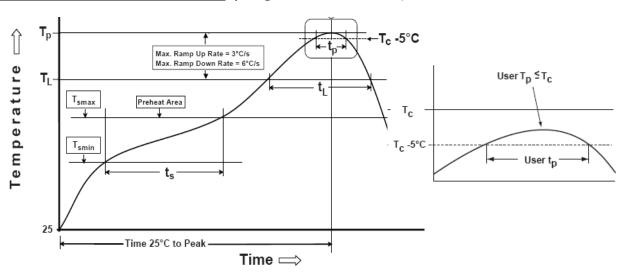
Pin 1	Tri-state	
(Rounded)		
Pin 2	Ground	
Pin 3	Output	
Pin 4:	Supply Voltage	

Group R is also available in these packages: **HM53**:

5x3.2x1.2 mm 4 pad ceramic SMDs

9.6x11.4x3.0 mm FR4 base leadless SMDs

Recommended Solder Reflow Profile (from_IPC/JEDEC J-STD-020D.1)

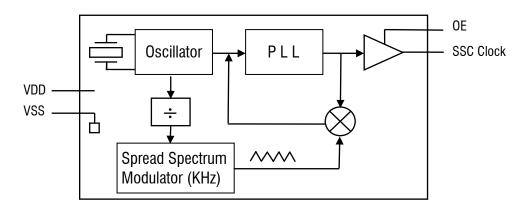




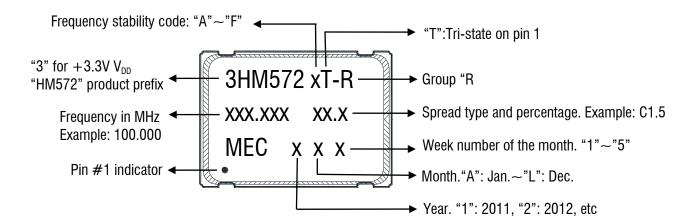
Profile Feature	Sn-Pb Eutectic Assembly	Pb-free Assembly
Preheat/Soak		
- Temperature min. (Ts min.)	100°C	150°C
- Temperature max. (Ts max.)	150°C	200°C
- Time (ts) (Ts min. to Ts max.)	60 to 120 seconds	60 to 180 seconds
Ramp-up rate (T _L to Tp)	3°C / sec. max.	3°C / sec. max.
Liquidous temperature (T _L)	183°C	217°C
Time (t _L) maintained above T _L	60 to 150 seconds	60 to 150 seconds
Peak package body temperature (Tp)	235°C	260°C
Time (Tp) within 5°C of the classification temperature Tc	10 to 30 seconds	20 to 40 seconds
Ramp-down rate (Tp to T _L)	6°C / second max.	6°C / second max.
Time 25°C to peak temperature	6 minutes max.	8 minutes max.

All temperatures refer to topside of the package, measured on the package body surface.

Block Diagram



Product Marking

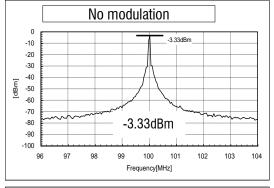


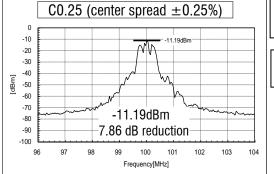
Product Support and Related Document

Technical note: <u>TN-020 "Low EMI Spread Spectrum Clock Oscillators"</u> Product Change Notice: <u>PCN-111004 "Change HM57 to HM572"</u>



EMI Reduction of 3HM572 100 MHz at C0.25, C0.5 and C1.5. The Main Mode and the Modulated Spectra.





Modulation carrier frequency is 34.87 KHz

C0.25 is for information only. Not an orderable option.

